

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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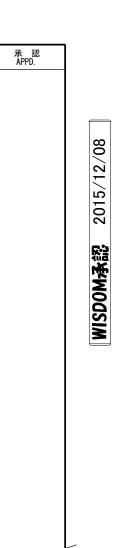
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変更内容 DESCRIPTION 年月日 D A T E CN NO. **L69911**CS ON BNIWARD(H 型 国 区) $8 \pm 0.2 (PITCH)$ $\phi 1.5 \pm 0.1$ NOTE 5 NOTE 3 11.7 3 ± 0.2 (15.2)(5 : 1) (2.76)NOIN ELECTRONICS, F 2 N $(\phi 600)$

- NOTE 1. THESE CONTACTS ARE SUPPLIED IN REEL. THERE ARE 6000 CONTACTS PER REEL. NOTE 2. APPLICABLE CABLE: AWG#22 TO #24, INSULATION OUTER DIAMETER: ϕ 0.9mm TO ϕ 1.5mm.

NOTE 4

- NOTE 3. PRODUCTION DATE IS SHOWN.

- NOTE 4. FORM IDENTIFICATION MARK IS SHOWN.
 NOTE 5. PRODUCT NAME, DRAWING NUMBER AND QUANTITY ARE SHOWN.
 NOTE 6. MATING AREA: GOLD PLATING OVER NICKEL, TERMINAL AREA: TIN PLATING OVER NICKEL OTHER AREA: NICKEL PLATING

- 注1. 本コンタクトは6000個巻きのリールにて供給される。 注2. 適用電線:AWG#22~#24、被覆外径: φ0.9~1.5mm 注3. 図示の位置に製造年月を表示する。 注4. 図示の位置に形状識別記号を表示する。 注5. 図示の位置に品名、図番、数量を表示する。 注6. 接触部:ニッケル上金めっき、結線部:ニッケル上錫めっき、その他:ニッケルめっき

	3	TAPE	1	PAPER		_	_
	2	REEL	1	PAPER		_	_
	1	SOCKET CONTACT	600	0 COPPER	R ALLOY	NOTE 6	_
	符号 NO.	名 称 DESCRIPTION	個 QTY	数	材 料 MATERIAL	仕 上 FINISH	備 考 REMARKS
ſ	仕様書(SPECIFICATION) 第1版(C			NAL DATE)	尺度(SC	ALE) シリーズ (SERIES)	

			4					
仕様書(SPECIFICATI JACS-11114(-*)		第1版(ORIGINAL DATE) O4/DEC/2015		尺度 (SCALE) 1:10	シリーズ(SERIES) HB01		電子工業株式会社	\mathbb{N}
		製図 DR.	_	名称(TITLE)	Refer	ence		A3
一般公差(GENERAL]	,	担当 CHK.	K. NAKAZAWA	HB01S06K4P1		ELECTRONICS		1ZE
<u>寸法(DIMENSION)</u> . ± 0.8	<u>角度(ANGLES)</u> ×° ±	查閱 APPD.	_	SOCKET CONT	ACT #22		INDUSTRY, LTD.	S
. × ±0.4	×° ×′ ±		T. KUDOU			図面番号(版数 (VER.)
. ×× ±0.1	単位(UNIT):mm			質量(MASS) -	———	S	J116697	1